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Atty Docket: 33144-180490

35976 U.S. PTO 10/132301



To the Honorable Commissioner of Patents and Trademarks: Please Record the attached original documents or copy thereof.

1. Name of conveying party(ies): Jong-Bor WANG Chii-Ming SHIAH 4-26-02 Additional name of conveying party(ies) attached? [] Yes [X] No

2. Name and address of receiving party(ies) Name: Winbond Electronics Corp. Internal Address: Street Address: No. 4, Creation Road III Science-Based Industrial Park City: Hsinchu State/Country: Taiwan, R.O.C. Zip: Additional Name(s) & address(es) attached? [] Yes [X] No

3. Nature of conveyance: [X] Assignment [] Merger [] Security Agreement [] Change of Name [] Other Execution Date: 4/16/02

4. Application number(s) or patent number(s): 10, 132 30/ If this document is being filed together with a new application, the execution date of the application by the first named inventor is: 4/16/02 A. Patent Application No.(s) B. Patent No.(s) Additional numbers attached? [] Yes [] No

5. Name and address of party to whom correspondence concerning this document should be mailed: 26694 PATENT TRADEMARK OFFICE Name: VENABLE Address: P.O. Box 34385 City: Washington State: D.C. Zip: 20043-9998

6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41) \$ 40 [X] Enclosed [] Authorized to be charged to deposit account 8. Deposit account number: (Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Fei-Fei Chao, Ph.D. Signature Date: April 26, 2002

Total number of pages including cover sheet, attachments, and documents: 2

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

ASSIGNMENT

(1-5) Insert Name(s) of Inventor(s).

- (1) Jong-Bor WANG
- (2) Chii-Ming SHIAH
- (3) _____
- (4) _____
- (5) _____

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(6) Winbond Electronics Corp.

(6) Insert name of Assignee

(7) Insert address of Assignee

(7) No. 4, Creation Rd. III, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

(hereinafter designated as the Assignee) the entire right, title and interest for the United States, its territories, dependencies and possessions, in the invention, and all applications for patent and any Letters Patent which may be granted therefor, known as

(8) Insert Identification of Invention, such as Title, Case Number or Foreign Application Number

(8) Method for Manufacturing an Extended-Wing Capacitor and The Extended-Wing Capacitor Foreign Application or Case No. _____

for which the undersigned has (have) executed an application for patent in the United States of America

(9) Insert Date of Signing of Application

(9) on April 16, 2002

(10) Alternative identification for filed applications

(10) U.S. application Serial Number _____
filed _____

1) The undersigned agree(s) to execute all papers necessary in connection with the application and any continuing or divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient or essential to its full protection and title in and to the invention hereby transferred.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division or re-issue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

4) The undersigned agree(s) to communicate to the Assignee or representatives thereof any facts known to me (us) respecting the invention and improvements thereof, and will, upon request, but without expense to me (us), testify in any legal proceedings regarding the invention.

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.

6) The undersigned hereby grant(s) the firm of Venable, Baetjer, Howard & Civiletti, LLP the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

7) This Assignment shall be binding upon my (our) heirs, executors, administrators, and/or assigns, and shall inure to the benefit of the heirs, executors, administrators, successors and/or assigns of the Assignee.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

- (1) Date April 16, 2002 Name of Inventor Wang, Jong-Bor
- (2) Date April 16, 2002 Name of Inventor Shiah, Chii-Ming
- (3) Date _____ Name of Inventor _____
- (4) Date _____ Name of Inventor _____
- (5) Date _____ Name of Inventor _____

PATENT